



SSC8040GS6

N-Channel Enhancement Mode MOSFET

➤ Features

V_{DS}	V_{GS}	$R_{DS(ON)}$ Typ.	I_D
40V	$\pm 20V$	24m Ω @10V	9A
		29m Ω @4V5	

➤ Description

This device uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications.

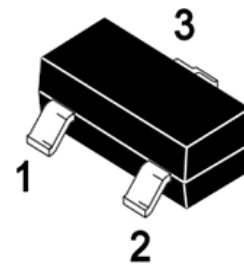
➤ Applications

- Load Switch
- Portable Devices
- DCDC Conversion

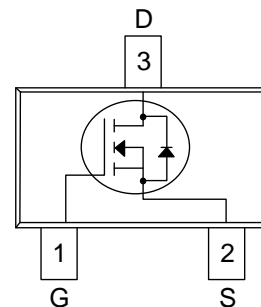
➤ Ordering Information

Device	Package	Shipping
SSC8040GS6	SOT-23	3000/Reel

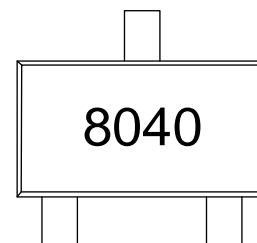
➤ Pin configuration



SOT-23



Pin Configuration (Top View)



Marking



➤ **Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
V_{DSS}	Drain-to-Source Voltage	40	V
V_{GSS}	Gate-to-Source Voltage	± 20	V
I_{D}	Continuous Drain Current ^a	9	A
I_{DM}	Pulsed Drain Current ^b	36	A
P_{D}	Power Dissipation ^c	1.25	W
T_{J}	Operation junction temperature	-55~150	$^{\circ}\text{C}$
T_{STG}	Storage temperature range	-55~150	$^{\circ}\text{C}$

➤ **Thermal Resistance Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)**

Symbol	Parameter	Maximum	Unit
$R_{\theta\text{JA}}$	Junction-to-Ambient Thermal Resistance ^a	98	$^{\circ}\text{C}/\text{W}$

Note:

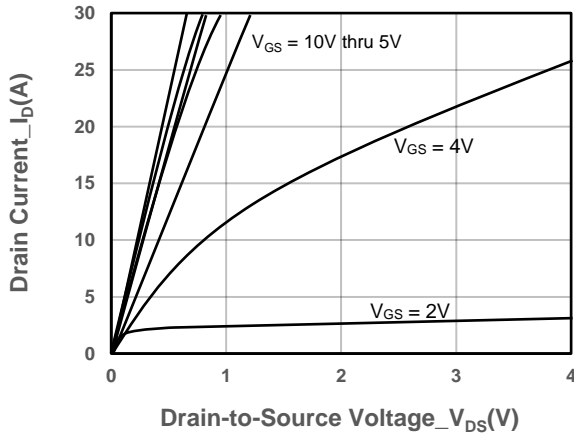
- The value of $R_{\theta\text{JA}}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The value in any given application depends on the user is specific board design. The power dissipation is based on the $t \leq 10\text{s}$ thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P_{D} is based on $T_{\text{J(MAX)}}=150^{\circ}\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

**➤ Electrical Characteristics (T_A=25°C unless otherwise noted)**

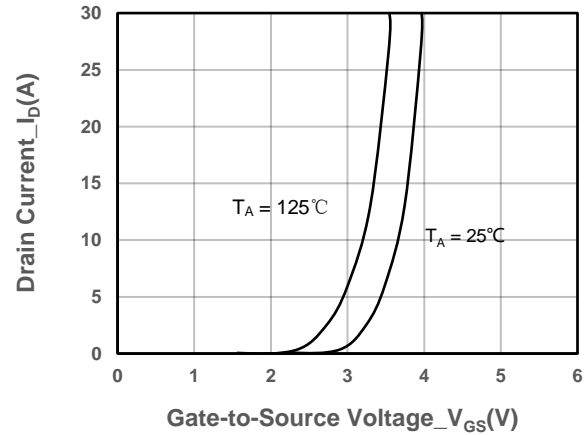
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250uA	1	1.5	2.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 5.8A		24	33	mΩ
		V _{GS} = 4.5V, I _D = 5A		29	38	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40V, V _{GS} = 0V			1	μA
Gate-Source Leak Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
Transconductance	G _{FS}	V _{DS} = 5V, I _D = 1A		20		s
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 1A			1.3	V
Input Capacitance	C _{ISS}	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		530		pF
Output Capacitance	C _{OSS}			68		
Reverse Transfer Capacitance	C _{RSS}			58		
Turn-on Delay Time	T _{D(ON)}	V _{GS} = 10V, I _D = 5A, V _{DS} = 20V, R _G = 3Ω		11		ns
Rise Time	T _r			9		
Turn-off Delay Time	T _{D(OFF)}			15		
Fall Time	T _f			10		
Total Gate Charge	Q _G	V _{GS} = 10V, V _{DS} = 20V, I _D = 5A		13.5		nC
Gate to Source Charge	Q _{GS}			1.7		
Gate to Drain Charge	Q _{GD}			2.2		



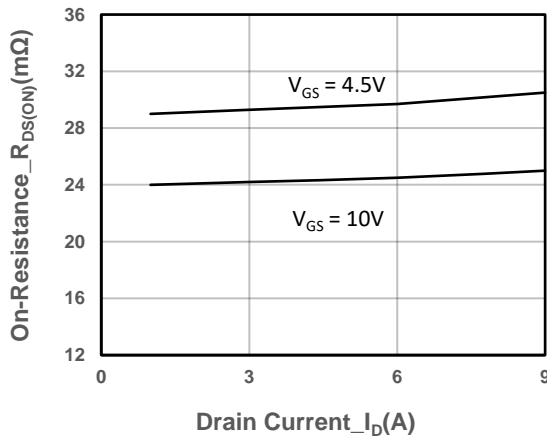
➤ Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)



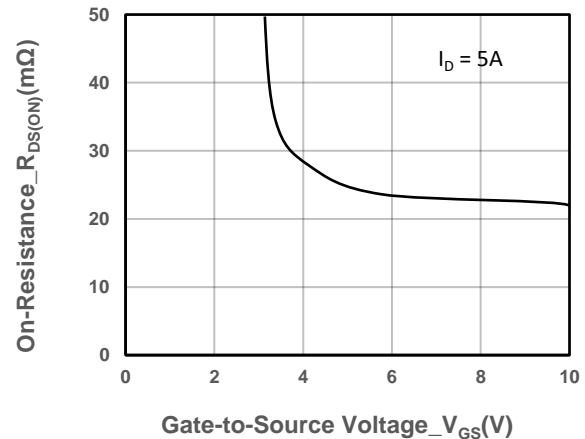
Output Characteristics



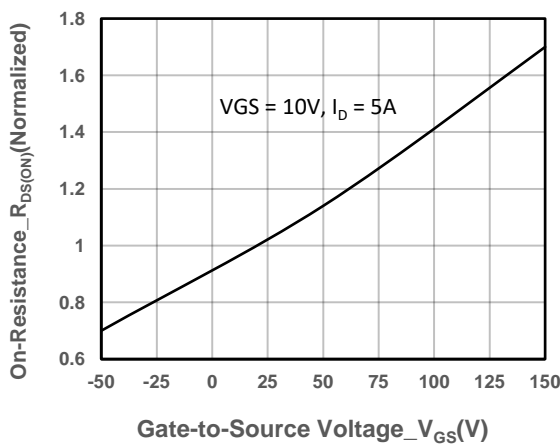
Transfer Characteristics



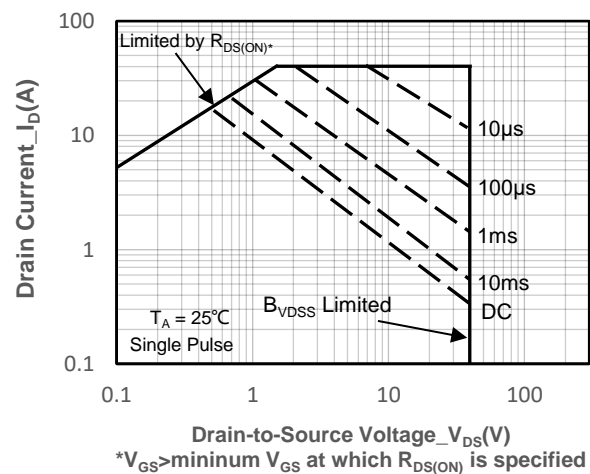
On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Gate-to-Source Voltage

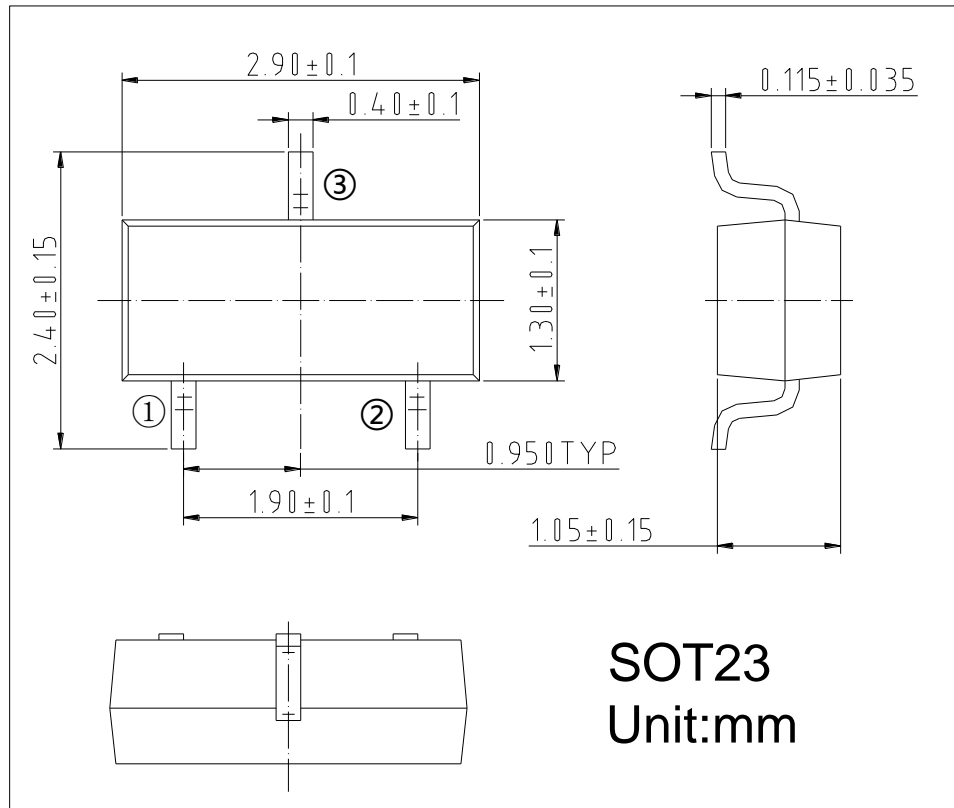


On-Resistance vs. Junction Temperature

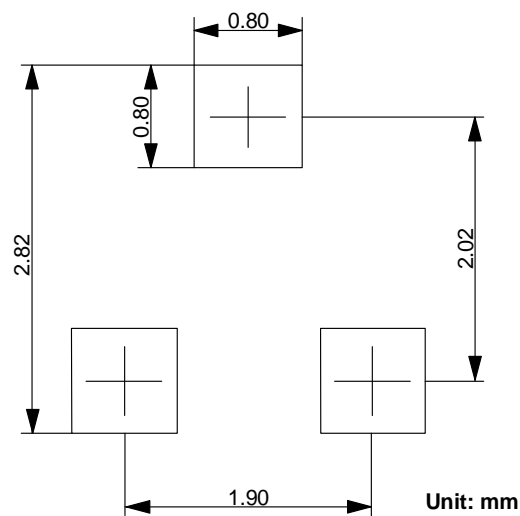


Safe Operating Area vs. Junction-to-Ambient

➤ Package Information



➤ Recommended Pad outline





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